Application No. 09/827,985
Amendment dated July 8, 2003
RESPONSE TO OFFICE ACTION dated April 10, 2003

AMENDMENTS TO THE SPECIFICATION:

Please replace paragraph **[0038]** on page 7 with the following rewritten paragraph:

--[0038] Cathode lead portion 122b extends through seam 116, formed in package 112 where the packaging laminate is sealed around cathode lead portion 122b. An adhesive/sealing band 142 is formed around cathode lead portion 122b to facilitate sealing and bonding of the packaging laminate to cathode lead portion 122b. The composition of sealing band 142, and a method of sealing the packaging laminate around cathode lead portion 122b is taught in U.S. Patent ~~Application No. 09/271,954~~ No. 6,267,790 to Daroux et al., the disclosure of which is expressly incorporated herein by reference.--

Please replace paragraph **[0048]** on page 10 with the following rewritten paragraph:

--[0048] Adhesive bands or strips 142 may be applied to portions of cathode lead portion 122b, as heretofore described in U.S. Patent ~~Application No. 09/271,954~~ No. 6,267,790 to Daroux et al. Multi-layer cell 100 is then packaged within flexible laminate 114 that is sealed around cathode lead portion 122b by the application of heat and pressure, as schematically illustrated in FIG. 6F, by arrows 182. In a similar fashion, anode current collector tabs 38 would be gathered together in stack 152 offset from the body of cell 100 and ultrasonically welded together, with anode lead 132, to form an anode weldment 138. Anode weldment 138 would be bent to a position similar to cathode weldment 128, and anode lead portion 132b would be wrapped over the end of anode weldment 138. Anode lead portion 132b would be sealed between layers of flexible laminate 114, as illustrated in FIG. 5. As will be appreciated by those skilled in the art, the sealing of laminate 114 around cathode lead portion 122 would occur simultaneously with the sealing of laminate 114 around anode lead portion 132b.--